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### Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

#### Details

Product StatusObsoleteCore Processor80C51Core Size8-BitSpeed30/20MHz	
Core Size 8-Bit	
Speed 30/20MHz	
Connectivity UART/USART	
Peripherals POR, PWM, WDT	
Number of I/O 32	
Program Memory Size 16KB (16K x 8)	
Program Memory Type OTP	
EEPROM Size -	
RAM Size 512 x 8	
Voltage - Supply (Vcc/Vdd) 2.7V ~ 5.5V	
Data Converters -	
Oscillator Type Internal	
Operating Temperature -40°C ~ 85°C (TA)	
Mounting Type Surface Mount	
Package / Case 44-LCC (J-Lead)	
Supplier Device Package44-PLCC (16.6x16.6)	
Purchase URL https://www.e-xfl.com/product-detail/microchip-technology/ts87c51rb2	2-lib

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# 4. SFR Mapping

The Special Function Registers (SFRs) of the TS80C51Rx2 fall into the following categories:

- C51 core registers: ACC, B, DPH, DPL, PSW, SP, AUXR1
- I/O port registers: P0, P1, P2, P3, P4, P5
- Timer registers: T2CON, T2MOD, TCON, TH0, TH1, TH2, TMOD, TL0, TL1, TL2, RCAP2L, RCAP2H
- Serial I/O port registers: SADDR, SADEN, SBUF, SCON
- Power and clock control registers: PCON
- HDW Watchdog Timer Reset: WDTRST, WDTPRG
- PCA registers: CL, CH, CCAPiL, CCAPiH, CCON, CMOD, CCAPMi
- Interrupt system registers: IE, IP, IPH
- Others: AUXR, CKCON

#### Table 1. All SFRs with their address and their reset value

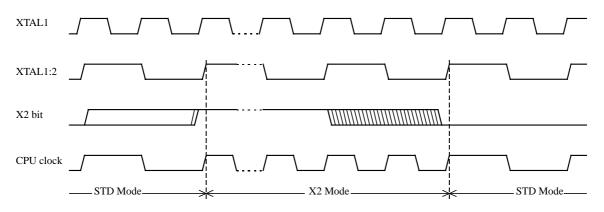
	Bit addressable		Non Bit addressable								
	0/8	1/9	2/A	3/B	4/C	5/D	6/E	7/F			
F8h		CH 0000 0000	CCAP0H XXXX XXXX	CCAP1H XXXX XXXX	CCAPL2H XXXX XXXX	CCAPL3H XXXX XXXX	CCAPL4H XXXX XXXX		FFh		
F0h	B 0000 0000								F7h		
E8h	P5 bit addressable 1111 1111	CL 0000 0000	CCAP0L XXXX XXXX	CCAP1L XXXX XXXX	CCAPL2L XXXX XXXX	CCAPL3L XXXX XXXX	CCAPL4L XXXX XXXX		EFh		
E0h	ACC 0000 0000								E7h		
D8h	CCON 00X0 0000	CMOD 00XX X000	CCAPM0 X000 0000	CCAPM1 X000 0000	CCAPM2 X000 0000	CCAPM3 X000 0000	CCAPM4 X000 0000		DFh		
D0h	PSW 0000 0000								D7h		
C8h	T2CON 0000 0000	T2MOD XXXX XX00	RCAP2L 0000 0000	RCAP2H 0000 0000	TL2 0000 0000	TH2 0000 0000			CFh		
C0h	P4 bit addressable 1111 1111							P5 byte addressable 1111 1111	C7h		
B8h	IP X000 000	SADEN 0000 0000							BFh		
B0h	P3 1111 1111							IPH X000 0000	B7h		
A8h	IE 0000 0000	SADDR 0000 0000							AFh		
A0h	P2 1111 1111		AUXR1 XXXX0XX0				WDTRST XXXX XXXX	WDTPRG XXXX X000	A7h		
98h	SCON 0000 0000	SBUF XXXX XXXX							9Fh		
90h	P1 1111 1111								97h		
88h	TCON 0000 0000	TMOD 0000 0000	TL0 0000 0000	TL1 0000 0000	TH0 0000 0000	TH1 0000 0000	AUXR XXXXXX00	CKCON XXXX XXX0	8Fh		
80h	P0 1111 1111	SP 0000 0111	DPL 0000 0000	DPH 0000 0000				PCON 00X1 0000	87h		
	0/8	1/9	2/A	3/B	4/C	5/D	6/E	7/F			
	macaminad										

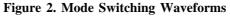
reserved



Reset	9	10	4	Ι	<b>Reset:</b> A high on this pin for two machine cycles while the oscillator is running, resets the device. An internal diffused resistor to $V_{SS}$ permits a power-on reset using only an external capacitor to $V_{CC}$ . If the hardware watchdog reaches its time-out, the reset pin becomes an output during the time the internal reset is
					activated.







The X2 bit in the CKCON register (See Table 3.) allows to switch from 12 clock cycles per instruction to 6 clock cycles and vice versa. At reset, the standard speed is activated (STD mode). Setting this bit activates the X2 feature (X2 mode).

### CAUTION

In order to prevent any incorrect operation while operating in X2 mode, user must be aware that all peripherals using clock frequency as time reference (UART, timers, PCA...) will have their time reference divided by two. For example a free running timer generating an interrupt every 20 ms will then generate an interrupt every 10 ms. UART with 4800 baud rate will have 9600 baud rate.



## 6.2. Dual Data Pointer Register Ddptr

The additional data pointer can be used to speed up code execution and reduce code size in a number of ways.

The dual DPTR structure is a way by which the chip will specify the address of an external data memory location. There are two 16-bit DPTR registers that address the external memory, and a single bit called DPS = AUXR1/bit0 (See Table 4.) that allows the program code to switch between them (Refer to Figure 3).

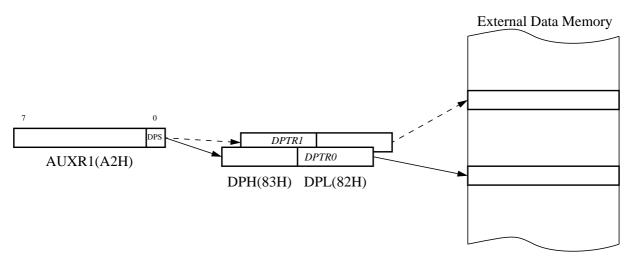


Figure 3. Use of Dual Pointer

 Table 4. AUXR1: Auxiliary Register 1

AUXR1 Address 0A2H		-	-	-	-	GF3	-	-	DPS
	Reset value	Х	Х	Х	Х	0	Х	Х	0

Symbol	Function						
-	Not implement	Not implemented, reserved for future use. <sup>a</sup>					
DPS	Data Pointer S	Data Pointer Selection.					
	DPS	DPS Operating Mode					
	0	DPTR0 Selected					
	1	1 DPTR1 Selected					
GF3	This bit is a g	This bit is a general purpose user flag <sup>b</sup> .					

a. User software should not write 1s to reserved bits. These bits may be used in future 8051 family products to invoke new feature. In that case, the reset value of the new bit will be 0, and its active value will be 1. The value read from a reserved bit is indeterminate.

b. GF3 will not be available on first version of the RC devices.

## Application

Software can take advantage of the additional data pointers to both increase speed and reduce code size, for example, block operations (copy, compare, search ...) are well served by using one data pointer as a 'source' pointer and the other one as a "destination" pointer.



## ASSEMBLY LANGUAGE

; Block move using dual data pointers ; Destroys DPTR0, DPTR1, A and PSW ; note: DPS exits opposite of entry state ; unless an extra INC AUXR1 is added

00A2	AUXR1 EQU 0A2H	
; 0000 909000 0003 05A2 0005 90A000	MOV DPTR,#SOURCE INC AUXR1 MOV DPTR,#DEST	; address of SOURCE ; switch data pointers ; address of DEST
0008 0008 05A2 000A E0	LOOP: INC AUXR1 MOVX A,@DPTR	; switch data pointers ; get a byte from SOURCE
000A E0 000B A3 000C 05A2 000E F0	INC DPTR INC AUXR1 MOVX @DPTR.A	; increment SOURCE address ; switch data pointers ; write the byte to DEST
000E F0 000F A3 0010 70F6 0012 05A2	INC DPTR JNZ LOOP INC AUXR1	; increment DEST address ; check for 0 terminator ; (optional) restore DPS

INC is a short (2 bytes) and fast (12 clocks) way to manipulate the DPS bit in the AUXR1 SFR. However, note that the INC instruction does not directly force the DPS bit to a particular state, but simply toggles it. In simple routines, such as the block move example, only the fact that DPS is toggled in the proper sequence matters, not its actual value. In other words, the block move routine works the same whether DPS is '0' or '1' on entry. Observe that without the last instruction (INC AUXR1), the routine will exit with DPS in the opposite state.



## 6.4. Timer 2

The timer 2 in the TS80C51RX2 is compatible with the timer 2 in the 80C52.

It is a 16-bit timer/counter: the count is maintained by two eight-bit timer registers, TH2 and TL2, connected in cascade. It is controlled by T2CON register (See Table 6) and T2MOD register (See Table 7). Timer 2 operation is similar to Timer 0 and Timer 1. C/T2 selects  $F_{OSC}/12$  (timer operation) or external pin T2 (counter operation) as the timer clock input. Setting TR2 allows TL2 to be incremented by the selected input.

Timer 2 has 3 operating modes: capture, autoreload and Baud Rate Generator. These modes are selected by the combination of RCLK, TCLK and  $CP/\overline{RL2}$  (T2CON), as described in the Atmel Wireless & Microcontrollers 8-bit Microcontroller Hardware description.

Refer to the Atmel Wireless & Microcontrollers 8-bit Microcontroller Hardware description for the description of Capture and Baud Rate Generator Modes.

In TS80C51RX2 Timer 2 includes the following enhancements:

- Auto-reload mode with up or down counter
- Programmable clock-output

## 6.4.1. Auto-Reload Mode

The auto-reload mode configures timer 2 as a 16-bit timer or event counter with automatic reload. If DCEN bit in T2MOD is cleared, timer 2 behaves as in 80C52 (refer to the Atmel Wireless & Microcontrollers 8-bit Microcontroller Hardware description). If DCEN bit is set, timer 2 acts as an Up/down timer/counter as shown in Figure 5. In this mode the T2EX pin controls the direction of count.

When T2EX is high, timer 2 counts up. Timer overflow occurs at FFFFh which sets the TF2 flag and generates an interrupt request. The overflow also causes the 16-bit value in RCAP2H and RCAP2L registers to be loaded into the timer registers TH2 and TL2.

When T2EX is low, timer 2 counts down. Timer underflow occurs when the count in the timer registers TH2 and TL2 equals the value stored in RCAP2H and RCAP2L registers. The underflow sets TF2 flag and reloads FFFFh into the timer registers.

The EXF2 bit toggles when timer 2 overflows or underflows according to the direction of the count. EXF2 does not generate any interrupt. This bit can be used to provide 17-bit resolution.



## 6.5. Programmable Counter Array PCA

The PCA provides more timing capabilities with less CPU intervention than the standard timer/counters. Its advantages include reduced software overhead and improved accuracy. The PCA consists of a dedicated timer/counter which serves as the time base for an array of five compare/ capture modules. Its clock input can be programmed to count any one of the following signals:

- Oscillator frequency  $\div$  12 ( $\div$  6 in X2 mode)
- Oscillator frequency  $\div$  4 ( $\div$  2 in X2 mode)
- Timer 0 overflow
- External input on ECI (P1.2)

Each compare/capture modules can be programmed in any one of the following modes:

- rising and/or falling edge capture,
- software timer,
- high-speed output, or
- pulse width modulator.

Module 4 can also be programmed as a watchdog timer (See Section "PCA Watchdog Timer", page 33).

When the compare/capture modules are programmed in the capture mode, software timer, or high speed output mode, an interrupt can be generated when the module executes its function. All five modules plus the PCA timer overflow share one interrupt vector.

The PCA timer/counter and compare/capture modules share Port 1 for external I/O. These pins are listed below. If the port is not used for the PCA, it can still be used for standard I/O.

PCA component	External I/O Pin
16-bit Counter	P1.2 / ECI
16-bit Module 0	P1.3 / CEX0
16-bit Module 1	P1.4 / CEX1
16-bit Module 2	P1.5 / CEX2
16-bit Module 3	P1.6 / CEX3
16-bit Module 4	P1.7 / CEX4

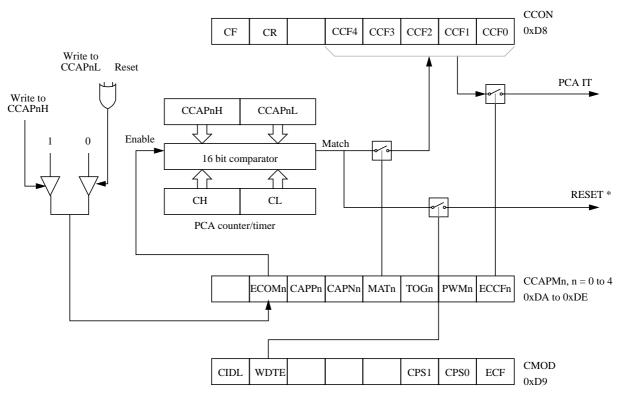
**The PCA timer** is a common time base for all five modules (See Figure 7). The timer count source is determined from the CPS1 and CPS0 bits in the **CMOD SFR** (See Table 8) and can be programmed to run at:

- 1/12 the oscillator frequency. (Or 1/6 in X2 Mode)
- 1/4 the oscillator frequency. (Or 1/2 in X2 Mode)
- The Timer 0 overflow
- The input on the ECI pin (P1.2)



## 6.5.2. 16-bit Software Timer / Compare Mode

The PCA modules can be used as software timers by setting both the ECOM and MAT bits in the modules CCAPMn register. The PCA timer will be compared to the module's capture registers and when a match occurs an interrupt will occur if the CCFn (CCON SFR) and the ECCFn (CCAPMn SFR) bits for the module are both set (See Figure 10).



\* Only for Module 4

### Figure 10. PCA Compare Mode and PCA Watchdog Timer

Before enabling ECOM bit, CCAPnL and CCAPnH should be set with a non zero value, otherwise an unwanted match could happen. Writing to CCAPnH will set the ECOM bit.

Once ECOM set, writing CCAPnL will clear ECOM so that an unwanted match doesn't occur while modifying the compare value. Writing to CCAPnH will set ECOM. For this reason, user software should write CCAPnL first, and then CCAPnH. Of course, the ECOM bit can still be controlled by accessing to CCAPMn register.



### 6.6.5. Reset Addresses

On reset, the SADDR and SADEN registers are initialized to 00h, i.e. the given and broadcast addresses are XXXX (all don't-care bits). This ensures that the serial port will reply to any address, and so, that it is backwards compatible with the 80C51 microcontrollers that do not support automatic address recognition.

### SADEN - Slave Address Mask Register (B9h)

7	6	5	4	3	2	1	0

Reset Value = 0000 0000b Not bit addressable

#### SADDR - Slave Address Register (A9h)

7	6	5	4	3	2	1	0

Reset Value = 0000 0000b Not bit addressable



## Table 17. PCON Register

#### PCON - Power Control Register (87h)

7	6	5	4		3	2	1	0
SMOD1	SMOD	) -	POI	F	GF1	GF0	PD	IDL
Bit Number	Bit Mnemonic	Description						
7	SMOD1	Serial port Mo Set to sele	<b>de bit 1</b> ct double baud ra	te in m	ode 1, 2 or 3.			
6	SMOD0		<b>de bit 0</b> ect SM0 bit in S0 lect FE bit in SC0					
5	-	Reserved The value	ead from this bit	is inde	terminate. Do not	set this bit.		
4	POF		cognize next reset		rom 0 to its nomin	al voltage. Can also	o be set by softwar	re.
3	GF1		se Flag user for general j for general purp					
2	GF0		se Flag user for general j for general purp					
1	PD	Power-Down mode bit Cleared by hardware when reset occurs. Set to enter power-down mode.						
0	IDL	Idle mode bit Clear by hardware when interrupt or reset occurs. Set to enter idle mode.						

Reset Value = 00X1 0000b Not bit addressable

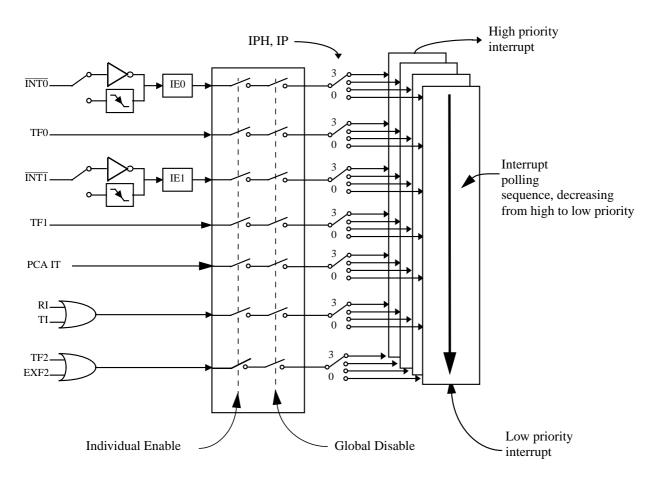
Power-off flag reset value will be 1 only after a power on (cold reset). A warm reset doesn't affect the value of this bit.



## 6.7. Interrupt System

The TS80C51Rx2 has a total of 7 interrupt vectors: two external interrupts ( $\overline{INT0}$  and  $\overline{INT1}$ ), three timer interrupts (timers 0, 1 and 2), the serial port interrupt and the PCA global interrupt. These interrupts are shown in Figure 16.

WARNING: Note that in the first version of RC devices, the PCA interrupt is in the lowest priority. Thus the order in INTO, TF0, INT1, TF1, RI or TI, TF2 or EXF2, PCA.



### Figure 16. Interrupt Control System

Each of the interrupt sources can be individually enabled or disabled by setting or clearing a bit in the Interrupt Enable register (See Table 19.). This register also contains a global disable bit, which must be cleared to disable all interrupts at once.

Each interrupt source can also be individually programmed to one out of four priority levels by setting or clearing a bit in the Interrupt Priority register (See Table 20.) and in the Interrupt Priority High register (See Table 21.). shows the bit values and priority levels associated with each combination.

The PCA interrupt vector is located at address 0033H. All other vector addresses are the same as standard C52 devices.



### Table 20. IP Register

#### **IP - Interrupt Priority Register (B8h)**

7	6	5	4	3	2	1	0
-	PPC	PT2	PS	PT1	PX1	PT0	PX0

Bit Number	Bit Mnemonic	Description						
7	-	Reserved The value read from	Reserved The value read from this bit is indeterminate. Do not set this bit.					
6	PPC	PCA interrupt priority Refer to PPCH for pr						
5	PT2	Timer 2 overflow interre Refer to PT2H for pr		it				
4	PS	Serial port Priority bit Refer to PSH for prio	ority level.					
3	PT1	Timer 1 overflow interre Refer to PT1H for pr		it				
2	PX1	External interrupt 1 Pri Refer to PX1H for pr						
1	PT0	Timer 0 overflow interre Refer to PT0H for pr		it				
0	PX0	External interrupt 0 Pri Refer to PX0H for pr						

Reset Value = X000 0000b Bit addressable



## 6.12. Power-Off Flag

The power-off flag allows the user to distinguish between a "cold start" reset and a "warm start" reset.

A cold start reset is the one induced by  $V_{CC}$  switch-on. A warm start reset occurs while  $V_{CC}$  is still applied to the device and could be generated for example by an exit from power-down.

The power-off flag (POF) is located in PCON register (See Table 26.). POF is set by hardware when  $V_{CC}$  rises from 0 to its nominal voltage. The POF can be set or cleared by software allowing the user to determine the type of reset.

The POF value is only relevant with a Vcc range from 4.5V to 5.5V. For lower Vcc value, reading POF bit will return indeterminate value.

#### Table 26. PCON Register

#### PCON - Power Control Register (87h)

7	6	5 4 3 2 1				1	0	
SMOD1	SMOD0	-	POF	GF1	GF0	PD	IDL	
Bit Number	Bit Mnemonic			Descrip	tion			
7	SMOD1	Serial port Mode bi Set to select dou	t <b>1</b> ble baud rate in m	ode 1, 2 or 3.				
6	SMOD0		t <b>0</b> M0 bit in SCON re E bit in SCON reg					
5	-	<b>Reserved</b> The value read fr	om this bit is inde	terminate. Do not s	set this bit.			
4	POF	Power-Off Flag Clear to recogniz Set by hardware	e next reset type. when V <sub>CC</sub> rises fr	om 0 to its nomina	l voltage. Can also	be set by software	<i>.</i> .	
3	GF1		<b>ag</b> for general purpose eneral purpose usa					
2	GF0	Cleared by user	General purpose Flag Cleared by user for general purpose usage. Set by user for general purpose usage.					
1	PD	Power-Down mode bit Cleared by hardware when reset occurs. Set to enter power-down mode.						
0	IDL	Idle mode bit Clear by hardwa Set to enter idle	re when interrupt on node.	or reset occurs.				

Reset Value = 00X1 0000b Not bit addressable



# 8. TS87C51RB2/RC2/RD2 EPROM

## 8.1. EPROM Structure

The TS87C51RB2/RC2/RD2 EPROM is divided in two different arrays:

•	the code array:
•	the encryption array:
In	addition a third non programmable array is implemented:
•	the signature array:

# 8.2. EPROM Lock System

The program Lock system, when programmed, protects the on-chip program against software piracy.

## 8.2.1. Encryption Array

Within the EPROM array are 64 bytes of encryption array that are initially unprogrammed (all FF's). Every time a byte is addressed during program verify, 6 address lines are used to select a byte of the encryption array. This byte is then exclusive-NOR'ed (XNOR) with the code byte, creating an encrypted verify byte. The algorithm, with the encryption array in the unprogrammed state, will return the code in its original, unmodified form.

When using the encryption array, one important factor needs to be considered. If a byte has the value FFh, verifying the byte will produce the encryption byte value. If a large block (>64 bytes) of code is left unprogrammed, a verification routine will display the content of the encryption array. For this reason all the unused code bytes should be programmed with random values. This will ensure program protection.

## 8.2.2. Program Lock Bits

The three lock bits, when programmed according to Table 29.8.2.3., will provide different level of protection for the on-chip code and data.

P	rogram Lo	ock Bits		Protection description				
Security level	LB1	LB2	LB3					
1	U	U	U	No program lock features enabled. Code verify will still be encrypted by the encryption array if programmed. MOVC instruction executed from external program memory returns non encrypted data.				
2	Р	U	U	MOVC instruction executed from external program memory are disabled from fetching code bytes from internal memory, $\overline{EA}$ is sampled and latched on reset, and further programming of the EPROM is disabled.				
3	U	Р	U	Same as 2, also verify is disabled.				
4	U	U	Р	Same as 3, also external execution is disabled.				

Table 29.	Program	Lock	bits
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U: unprogrammed,

P: programmed

WARNING: Security level 2 and 3 should only be programmed after EPROM and Core verification.

## 8.2.3. Signature bytes

The TS87C51RB2/RC2/RD2 contains 4 factory programmed signatures bytes. To read these bytes, perform the process described in section 8.3.



## **8.3. EPROM Programming**

## 8.3.1. Set-up modes

In order to program and verify the EPROM or to read the signature bytes, the TS87C51RB2/RC2/RD2 is placed in specific set-up modes (See Figure 18.).

Control and program signals must be held at the levels indicated in Table 30.

## **8.3.2.** Definition of terms

Address Lines: P1.0-P1.7, P2.0-P2.5, P3.4, P3.5 respectively for A0-A15 (P2.5 (A13) for RB, P3.4 (A14) for RC, P3.5 (A15) for RD)

Data Lines: P0.0-P0.7 for D0-D7

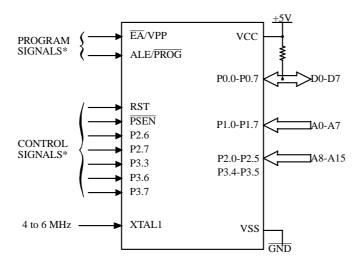
**Control Signals:** RST, <u>PSEN</u>, P2.6, P2.7, P3.3, P3.6, P3.7.

Program Signals: ALE/PROG, EA/VPP.

Mode	RST	PSEN	ALE/ PROG	<b>EA</b> /VPP	P2.6	P2.7	P3.3	P3.6	P3.7
Program Code data	1	0	Г	12.75V	0	1	1	1	1
Verify Code data	1	0	1	1	0		0	1	1
Program Encryption Array Address 0-3Fh	1	0	Г	12.75V	0	1	1	0	1
Read Signature Bytes	1	0	1	1	0		0	0	0
Program Lock bit 1	1	0	Г	12.75V	1	1	1	1	1
Program Lock bit 2	1	0	Г	12.75V	1	1	1	0	0
Program Lock bit 3	1	0	Г	12.75V	1	0	1	1	0

Table 30. EPROM Set-Up Modes





\* See Table 31. for proper value on these inputs

Figure 18. Set-Up Modes Configuration

## 8.3.3. Programming Algorithm

The Improved Quick Pulse algorithm is based on the Quick Pulse algorithm and decreases the number of pulses applied during byte programming from 25 to 1.

To program the TS87C51RB2/RC2/RD2 the following sequence must be exercised:

- Step 1: Activate the combination of control signals.
- Step 2: Input the valid address on the address lines.
- Step 3: Input the appropriate data on the data lines.
- Step 4: Raise  $\overline{EA}/VPP$  from VCC to VPP (typical 12.75V).
- Step 5: Pulse ALE/PROG once.
- Step 6: Lower  $\overline{EA}/VPP$  from VPP to VCC

Repeat step 2 through 6 changing the address and data for the entire array or until the end of the object file is reached (See Figure 19.).

## 8.3.4. Verify algorithm

Code array verify must be done after each byte or block of bytes is programmed. In either case, a complete verify of the programmed array will ensure reliable programming of the TS87C51RB2/RC2/RD2.

P 2.7 is used to enable data output.

To verify the TS87C51RB2/RC2/RD2 code the following sequence must be exercised:

- Step 1: Activate the combination of program and control signals.
- Step 2: Input the valid address on the address lines.
- Step 3: Read data on the data lines.

Repeat step 2 through 3 changing the address for the entire array verification (See Figure 19.)

The encryption array cannot be directly verified. Verification of the encryption array is done by observing that the code array is well encrypted.



## 10.3. DC Parameters for Standard Voltage

TA = 0°C to +70°C; V<sub>SS</sub> = 0 V; V<sub>CC</sub> = 5 V ± 10%; F = 0 to 40 MHz. TA = -40°C to +85°C; V<sub>SS</sub> = 0 V; V<sub>CC</sub> = 5 V ± 10%; F = 0 to 40 MHz.

### Table 32. DC Parameters in Standard Voltage

Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions
V <sub>IL</sub>	Input Low Voltage	-0.5		0.2 V <sub>CC</sub> - 0.1	v	
V <sub>IH</sub>	Input High Voltage except XTAL1, RST	0.2 V <sub>CC</sub> + 0.9		V <sub>CC</sub> + 0.5	V	
V <sub>IH1</sub>	Input High Voltage, XTAL1, RST	0.7 V <sub>CC</sub>		V <sub>CC</sub> + 0.5	V	
V <sub>OL</sub>	Output Low Voltage, ports 1, 2, 3, 4, 5 <sup>(6)</sup>			0.3 0.45 1.0	V V V	$\begin{split} I_{OL} &= 100 \; \mu A^{(4)} \\ I_{OL} &= 1.6 \; m A^{(4)} \\ I_{OL} &= 3.5 \; m A^{(4)} \end{split}$
V <sub>OL1</sub>	Output Low Voltage, port 0 <sup>(6)</sup>			0.3 0.45 1.0	V V V	$I_{OL} = 200 \ \mu A^{(4)}$ $I_{OL} = 3.2 \ m A^{(4)}$ $I_{OL} = 7.0 \ m A^{(4)}$
V <sub>OL2</sub>	Output Low Voltage, ALE, PSEN			0.3 0.45 1.0	V V V	$I_{OL} = 100 \ \mu A^{(4)}$ $I_{OL} = 1.6 \ m A^{(4)}$ $I_{OL} = 3.5 \ m A^{(4)}$
V <sub>OH</sub>	Output High Voltage, ports 1, 2, 3, 4, 5	V <sub>CC</sub> - 0.3 V <sub>CC</sub> - 0.7 V <sub>CC</sub> - 1.5			V V V	$I_{OH} = -10 \ \mu A$ $I_{OH} = -30 \ \mu A$ $I_{OH} = -60 \ \mu A$ $V_{CC} = 5 \ V \pm 10\%$
V <sub>OH1</sub>	Output High Voltage, port 0	V <sub>CC</sub> - 0.3 V <sub>CC</sub> - 0.7 V <sub>CC</sub> - 1.5			V V V	$I_{OH} = -200 \ \mu A$ $I_{OH} = -3.2 \ m A$ $I_{OH} = -7.0 \ m A$ $V_{CC} = 5 \ V \pm 10\%$
V <sub>OH2</sub>	Output High Voltage, ALE, PSEN	V <sub>CC</sub> - 0.3 V <sub>CC</sub> - 0.7 V <sub>CC</sub> - 1.5			V V V	$I_{OH} = -100 \ \mu A$ $I_{OH} = -1.6 \ m A$ $I_{OH} = -3.5 \ m A$ $V_{CC} = 5 \ V \pm 10\%$
R <sub>RST</sub>	RST Pulldown Resistor	50	90 <sup>(5)</sup>	200	kΩ	
I <sub>IL</sub>	Logical 0 Input Current ports 1, 2, 3, 4, 5			-50	μΑ	Vin = 0.45 V
I <sub>LI</sub>	Input Leakage Current			±10	μΑ	0.45 V < Vin < V <sub>CC</sub>
I <sub>TL</sub>	Logical 1 to 0 Transition Current, ports 1, 2, 3, 4, 5			-650	μΑ	Vin = 2.0 V
C <sub>IO</sub>	Capacitance of I/O Buffer			10	pF	$Fc = 1 MHz$ $TA = 25^{\circ}C$
I <sub>PD</sub>	Power Down Current		20 <sup>(5)</sup>	50	μΑ	$2.0 \text{ V} < \text{V}_{\text{CC}} < 5.5 \text{ V}^{(3)}$
I <sub>CC</sub> under RESET	Power Supply Current Maximum values, X1 mode: <sup>(7)</sup>			1 + 0.4 Freq (MHz) @12MHz 5.8 @16MHz 7.4	mA	$V_{CC} = 5.5 V^{(1)}$



Symbol	Туре	Standard Clock	X2 Clock	-М	-V	-L	Units
T <sub>XLXL</sub>	Min	12 T	6 T				ns
T <sub>QVHX</sub>	Min	10 T - x	5 T - x	50	50	50	ns
T <sub>XHQX</sub>	Min	2 T - x	T - x	20	20	20	ns
T <sub>XHDX</sub>	Min	х	х	0	0	0	ns
T <sub>XHDV</sub>	Max	10 T - x	5 T- x	133	133	133	ns

Table 44. AC Parameters	s for a	Variable	Clock:	derating formula
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# 10.5.8. Shift Register Timing Waveforms

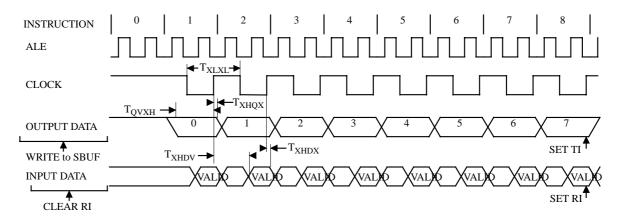


Figure 28. Shift Register Timing Waveforms



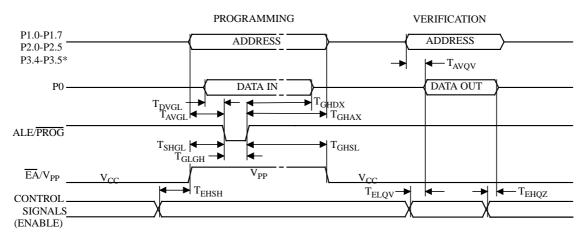
## **10.5.9. EPROM Programming and Verification Characteristics**

TA = 21°C to 27°C;  $V_{SS} = 0V$ ;  $V_{CC} = 5V \pm 10\%$  while programming.  $V_{CC}$  = operating range while verifying

Symbol	Parameter	Min	Max	Units
V <sub>PP</sub>	Programming Supply Voltage	12.5	13	v
I <sub>PP</sub>	Programming Supply Current		75	mA
1/T <sub>CLCL</sub>	Oscillator Frquency	4	6	MHz
T <sub>AVGL</sub>	Address Setup to PROG Low	48 T <sub>CLCL</sub>		
T <sub>GHAX</sub>	Adress Hold after PROG	48 T <sub>CLCL</sub>		
T <sub>DVGL</sub>	Data Setup to PROG Low	48 T <sub>CLCL</sub>		
T <sub>GHDX</sub>	Data Hold after PROG	48 T <sub>CLCL</sub>		
T <sub>EHSH</sub>	(Enable) High to V <sub>PP</sub>	48 T <sub>CLCL</sub>		
T <sub>SHGL</sub>	V <sub>PP</sub> Setup to PROG Low	10		μs
T <sub>GHSL</sub>	V <sub>PP</sub> Hold after PROG	10		μs
T <sub>GLGH</sub>	PROG Width	90	110	μs
T <sub>AVQV</sub>	Address to Valid Data		48 T <sub>CLCL</sub>	
T <sub>ELQV</sub>	ENABLE Low to Data Valid		48 T <sub>CLCL</sub>	
T <sub>EHQZ</sub>	Data Float after ENABLE	0	48 T <sub>CLCL</sub>	

### Table 45. EPROM Programming Parameters

## **10.5.10. EPROM Programming and Verification Waveforms**



\* 8KB: up to P2.4, 16KB: up to P2.5, 32KB: up to P3.4, 64KB: up to P3.5

### Figure 29. EPROM Programming and Verification Waveforms

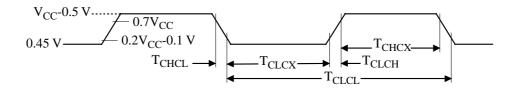


## **10.5.11. External Clock Drive Characteristics (XTAL1)**

Table	46.	AC	Parameters
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Symbol	Parameter	Min	Max	Units
T <sub>CLCL</sub>	Oscillator Period	25		ns
T <sub>CHCX</sub>	High Time	5		ns
T <sub>CLCX</sub>	Low Time	5		ns
T <sub>CLCH</sub>	Rise Time		5	ns
T <sub>CHCL</sub>	Fall Time		5	ns
T <sub>CHCX</sub> /T <sub>CLCX</sub>	Cyclic ratio in X2 mode	40	60	%

## 10.5.12. External Clock Drive Waveforms



### Figure 30. External Clock Drive Waveforms

### 10.5.13. AC Testing Input/Output Waveforms

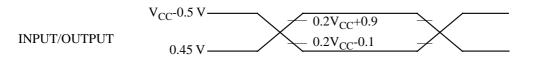


Figure 31. AC Testing Input/Output Waveforms

AC inputs during testing are driven at  $V_{CC}$  - 0.5 for a logic "1" and 0.45V for a logic "0". Timing measurement are made at  $V_{IH}$  min for a logic "1" and  $V_{IL}$  max for a logic "0".

### **10.5.14. Float Waveforms**

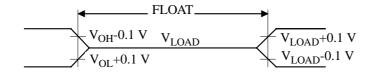


Figure 32. Float Waveforms